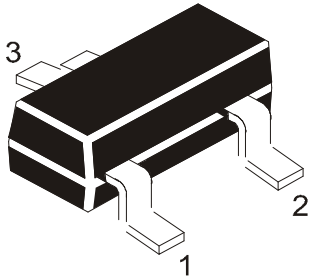


NPN SILICON PLANAR EPITAXIAL TRANSISTOR

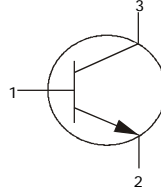
BCX41

SOT-23 Formed SMD Package



PIN CONFIGURATION (NPN)

- 1 = BASE
- 2 = EMITTER
- 3 = COLLECTOR



MARKING
BCX41=EK

Medium Power Transistor

ABSOLUTE MAXIMUM RATINGS (T_a=25°C)

DESCRIPTION	SYMBOL	VALUE	UNITS
Collector Emitter Voltage	V _{CEs}	125	V
Collector Emitter Voltage	V _{CEO}	125	V
Emitter Base Voltage	V _{EBO}	5.0	V
Peak Pulse Current	I _{CM}	1.0	A
Continuous Collector Current	I _C	800	mA
Base Current	I _B	100	mA
Power Dissipation	P _{tot}	330	mW
Operating and Storage Temperature Range	T _j , T _{stg}	- 55 to +150	°C

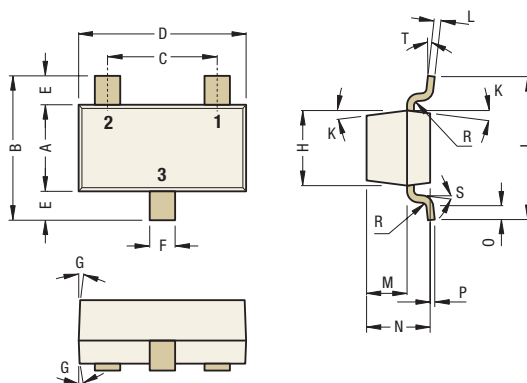
Electrical Characteristics (T_a=25°C unless specified otherwise)

DESCRIPTION	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNIT
Collector Base Cut Off Current	I _{CEs}	V _{CE} =100V, V _{BE} =0			100	nA
		V _{CE} =100V, V _{BE} =0, T _{amb} =150°C			10	µA
Collector Cut Off Current	I _{CEX}	V _{CE} =100V, V _{BE} =0.2V, T _{amb} =85°C			10	µA
		V _{CE} =100V, V _{BE} =0.2V, T _{amb} =125°C			75	µA
Emitter Cut Off Current	I _{EBO}	V _{EB} =4V, I _C =0			100	nA
Collector Emitter Saturation Voltage	*V _{CE(sat)}	I _C =300mA, I _B =30mA			0.9	V
Base Emitter Saturation Voltage	*V _{BE(sat)}	I _C =300mA, I _B =30mA			1.4	V
DC Current Gain	h _{FE}	I _C =100µA, V _{CE} =1V	25			
		*I _C =100mA, V _{CE} =1V	63			
		*I _C =200mA, V _{CE} =1V	40			
Transition Frequency	f _T	I _C =10mA, V _{CE} =5V, f=20 MHz		100		MHz
Output Capacitance	C _{obO}	V _{CB} =10V, I _E =0, f=1MHz		12		pF

*Pulse width=300µs, duty cycle=2%

BCX41 Rev 240310E

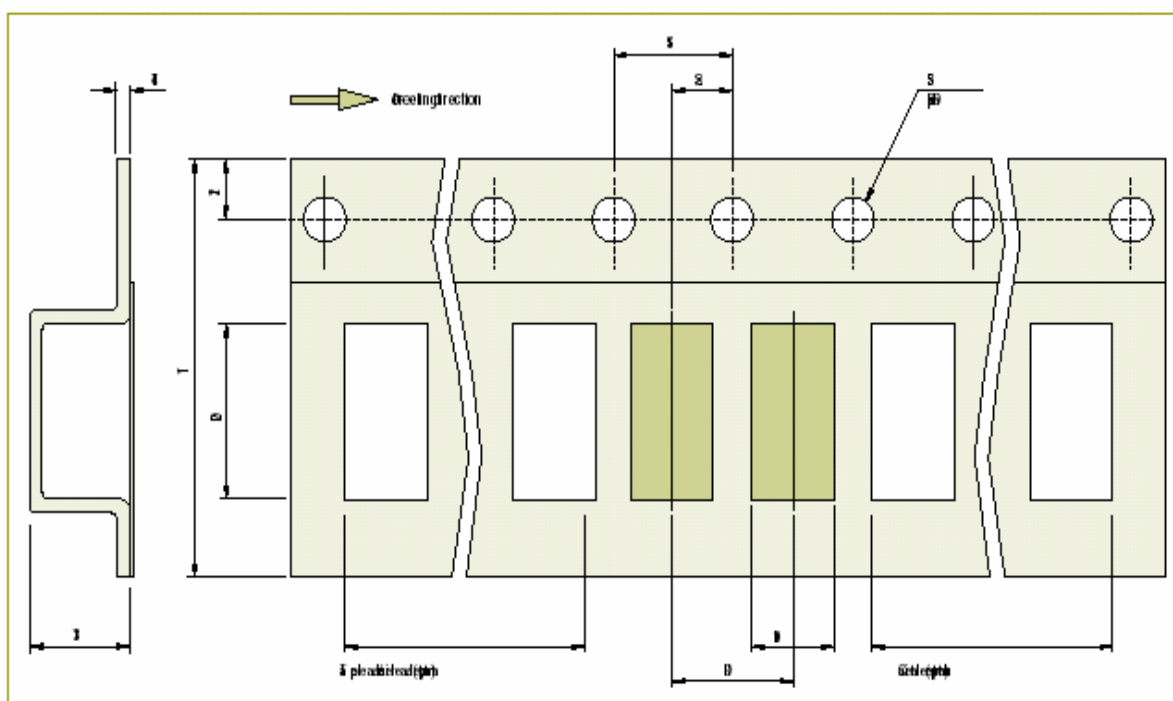
SOT-23
 SMD Plastic Package



DIM	Min	Max
A	1.20	1.40
B	2.10	2.64
C	1.85	1.95
D	2.80	3.04
E	0.54	0.67
F	0.30	0.50
G	3°	
H	—	1.30
J	2.10	2.64

DIM	Min	Max
K	7°	
L	0.08	0.20
M	0.58	0.62
N	0.70	1.02
O	0.21	—
P	0.02	0.15
R	—	0.08
S	2°	8°
T	2°	10°

Packaging Tape Specifications for SMD Packages



SMD Tape Specifications (8-12 mm)

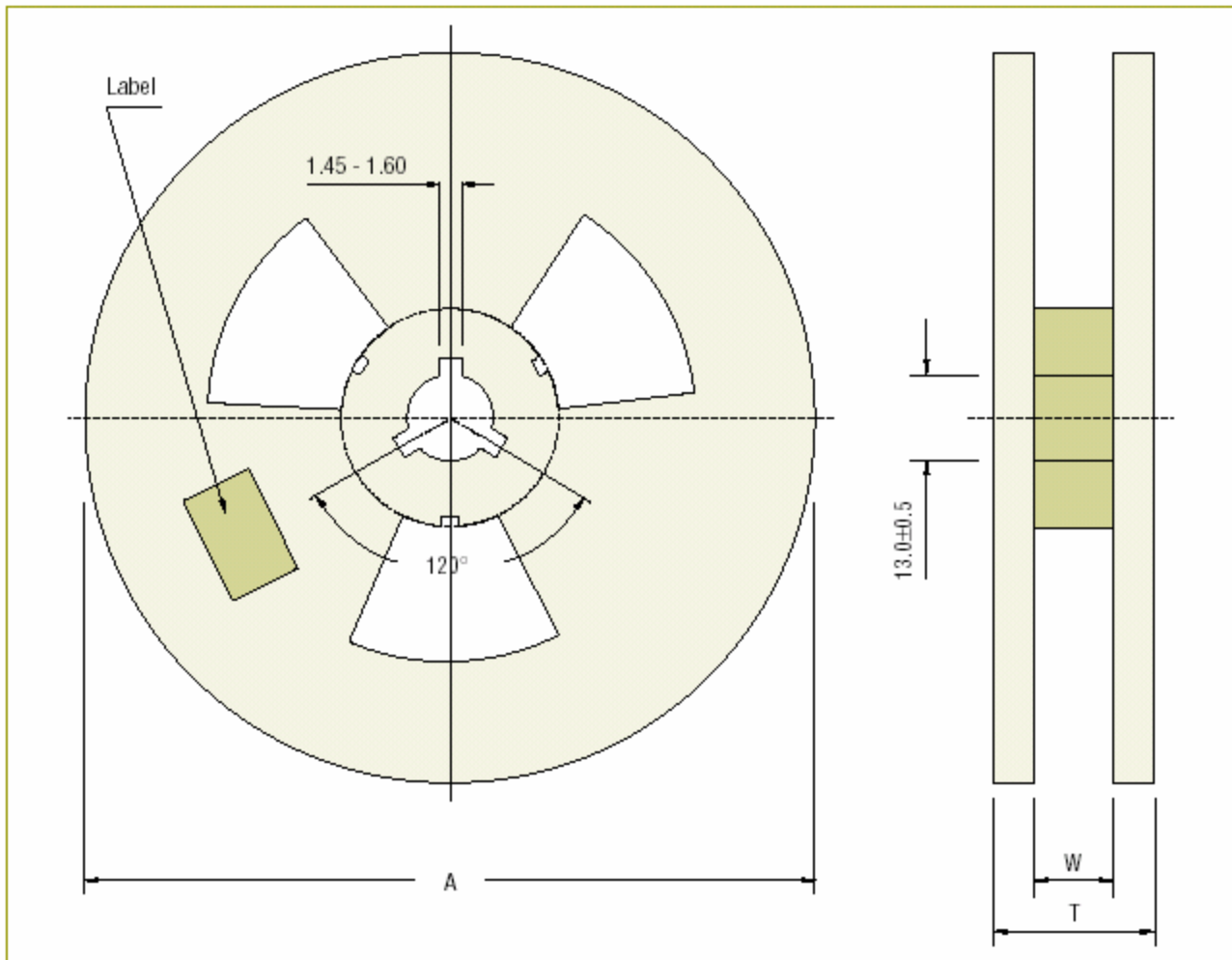
Device	D1	D2	D3	T1	T2	T3	T4	S1	S2	S3
						Max	Max			Dia
	mm	mm	mm	mm	mm	mm	mm	mm	mm	mm
SOT-23	3.2±0.1	2.8±0.1	4.0±0.1	8.0±0.2	1.75±0.1	1.60	0.35	4.0±0.1	2.0±0.1	1.5±0.1

Packaging Specifications ...

T & A: Tape and Ammo Pack; T & R: Tape and Reel; Bulk: Loose in Poly Bags; Tube: Tube and Carton; K: 1,000

Package / Case Type	Packaging Type	Std. Packing	Inner Carton			Outer Carton		
		Qty	Qty	Size L x W x H (cm)	Gross Weight (Kg)	Qty	Size L x W x H (cm)	Gross Weight (Kg)
SOT-23	T & R	3,000	15K	19 x 19 x 8	0.6	51K	23 x 23 x 23	2.2
	T & R	3,000	15K	19 x 19 x 8	0.6	408K	48 x 48 x 51	20.2
	T & R	10,000	50K	35.5 x 35.5 x 8.9	2.4	350K	48 x 48 x 51	19.2

Reel Specifications for SMD Packages



Reel Specifications

Package	Tape Width	Reel Dia. A - Max	Devices per Reel and MOQ	Inside Thickness W	Reel Thickness T - Max
SOT-23	8	180	3,000	8.4±2	14.4
	8	330	10,000	8.4±2	14.4

Component Disposal Instructions

1. CDIL Semiconductor Devices are RoHS compliant, customers are requested to please dispose as per prevailing Environmental Legislation of their Country.
2. In Europe, please dispose as per EU Directive 2002/96/EC on Waste Electrical and Electronic Equipment (WEEE).

Disclaimer

The product information and the selection guides facilitate selection of the CDIL's Semiconductor Device(s) best suited for application in your product(s) as per your requirement. It is recommended that you completely review our Data Sheet(s) so as to confirm that the Device(s) meet functionality parameters for your application. The information furnished on the CDIL Web Site/CD are believed to be accurate and reliable. CDIL however, does not assume responsibility for inaccuracies or incomplete information. Furthermore, CDIL does not assume liability whatsoever, arising out of the application or use of any CDIL product; neither does it convey any license under its patent rights nor rights of others. These products are not designed for use in life saving/support appliances or systems. CDIL customers selling these products (either as individual Discrete Semiconductor Devices or incorporated in their end products), in any life saving/support appliances or systems or applications do so at their own risk and CDIL will not be responsible for any damages resulting from such sale(s).

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